





60V PNP MEDIUM POWER TRANSISTOR PowerDI[®]5

Features

- 43% smaller than SOT223; 60% smaller than TO252
- Maximum height just 1.1mm
- Rated up to 3.2W
- $V_{CEO} = 60V$
- $I_C = -5.5A$; $I_{CM} = 15A$
- Low Saturation voltage
- Lead, Halogen, and Antimony Free/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

Applications

- Motor driver
- Regulator circuit

Mechanical Data

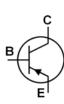
- Case: PowerDI®5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.093 grams (approximate)



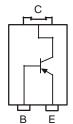




Bottom View



Device Schematic



Pin-out diagram

Ordering Information (Note 3)

Part Number	Case	Packaging
DXT2012P5-13	PowerDI [®] 5	5000/Tape & Reel

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com
- 3. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



DXT2012 = Product Type Marking Code Oll = Manufacturers' Code Marking K = Factory Designator YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 09 for 2009) WW = Week code 01 to 53





Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-100	V
Collector-Emitter Voltage	V _{CEO}	-60	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	Ic	-5.5	A
Peak Pulse Current	I _{CM}	-15	A

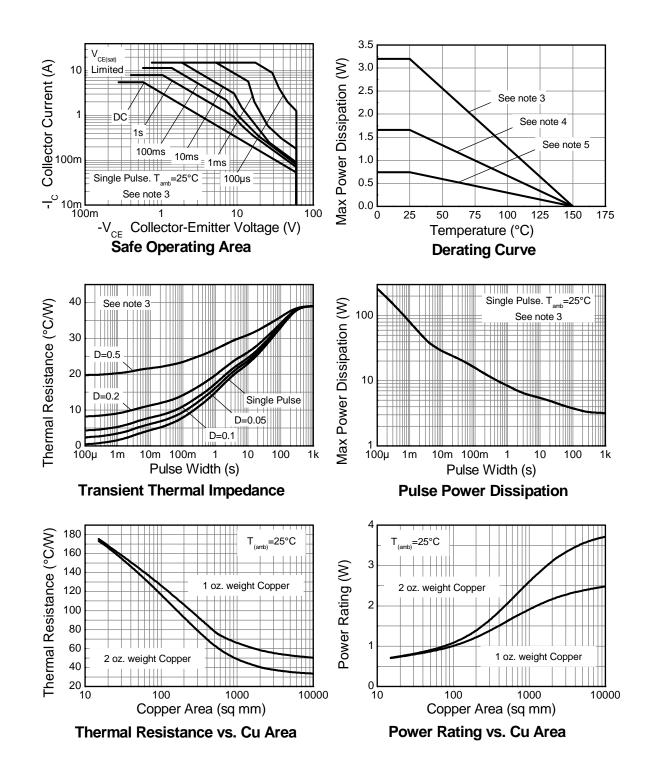
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation @ T _A = 25°C (Note 4)	P_{D}	3.2	W
Thermal Resistance, Junction to Ambient Air (Note 4) @T _A = 25°C	$R_{\theta JA}$	39	°C/W
Power Dissipation @ T _A = 25°C (Note 5)	P _D	1.7	W
Thermal Resistance, Junction to Ambient Air (Note 5) @T _A = 25°C	$R_{\theta JA}$	75	°C/W
Power Dissipation @ T _A = 25°C (Note 6)	P_{D}	0.74	W
Thermal Resistance, Junction to Ambient Air (Note 6) @T _A = 25°C	$R_{\theta JA}$	169	°C/W
Thermal Resistance, Junction to Collector Terminal	$R_{ heta JT}$	5.6	°C/W
Operating and Storage Temperature Range	T_J,T_STG	-55 to +150	°C

Notes:

- Device mounted on FR-4 PCB, single sided 2 oz. copper, collector pad dimensions 50mm x 50mm.
 Device mounted on FR-4 PCB, single sided 1 oz. copper, collector pad dimensions 25mm x 25mm.
 Device mounted on FR-4 PCB, 2 single sided 1oz. copper, minimum recommended pad layout.









Electrical Characteristics @T_A = 25°C unless otherwise specified

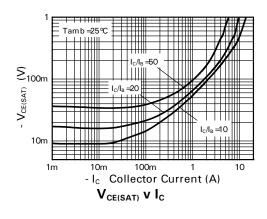
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-100	-120	-	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 7)	V _{(BR)CEO}	-60	-80	-	V	$I_C = -10 \text{mA}$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	-7	-8.1	-	٧	$I_E = -100 \mu A$
Collector Cutoff Current	I _{CBO}	-	<1 -	-20 -0.5	nA μA	$V_{CB} = -80V$ $V_{CB} = -80V$, $T_{amb} = 100 ^{\circ}C$
Collector Cutoff Current	I _{CER} R≤1kΩ	-	<1 -	-20 -0.5	nA μA	V _{CB} = -80V V _{CB} = -80V, T _{amb} = 100 °C
Emitter Cutoff Current	I _{EBO}	_	<1	-10	nA	V _{EB} = -6V
Collector-Emitter Saturation Voltage (Note 7)	V _{CE(sat)}	- - -	-15 -55 -90 -195	-25 -70 -120 -250	mV	I _C = -0.1A, I _B = -10mA I _C = -1A, I _B = -100mA I _C = -2A, I _B = -200mA I _C = -5A, I _B = -500mA
Base-Emitter Saturation Voltage (Note 7)	V _{BE(sat)}	_	-1030	-1150	mV	$I_C = -5A$, $I_B = -500mA$
Base-Emitter Turn-On Voltage (Note 7)	V _{BE(on)}	_	-920	-1020	mV	$V_{CE} = -1V, I_{C} = -5A$
DC Current Gain (Note 7)	h _{FE}	100 100 45 10	250 200 90 25	300 - -	I	V _{CE} = -1V, I _C = -10mA V _{CE} = -1V, I _C = -2A V _{CE} = -1V, I _C = -5A V _{CE} = -1V, I _C = -10A
Transition Frequency	f _T	I	120	=	MHz	$V_{CE} = -10V, I_{C} = -100mA,$ f = 50MHz
Output Capacitance	C _{obo}	l	48	_	pF	V _{CB} = -10V, f = 1MHz
Switching Times	t _{on} t _{off}	1 -	39 370	<u> </u>	ns	$V_{CC} = 10V, I_C = 1A,$ $I_{B1} = I_{B2} = -100mA$

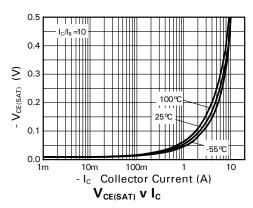
Notes: 7. Pulse Test: Pulse width $\leq 300 \mu s$. Duty cycle $\leq 2.0\%$.

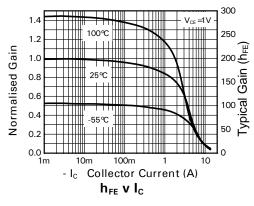


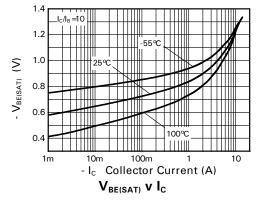


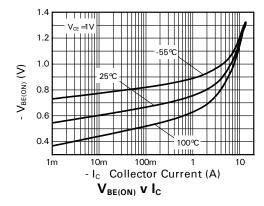
Typical Characteristic





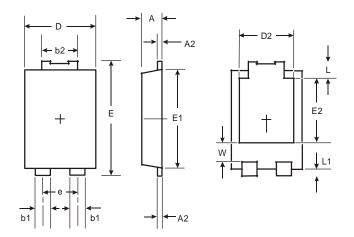






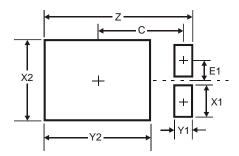


Package Outline Dimensions



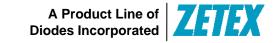
PowerDI [®] 5				
Dim	Min	Max		
Α	1.05	1.15		
A2	0.33	0.43		
b1	0.80	0.99		
b2	1.70	1.88		
D	3.90	4.05		
D2	3.054 Typ			
Е	6.40	6.60		
е	1.84 Typ			
E1	5.30	5.45		
E2	3.549 Typ			
١	0.75	0.95		
L1	0.50	0.65		
W	1.10	1.41		
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	6.6
X1	1.4
X2	3.6
Y1	0.8
Y2	4.7
C	3.87
E4	0.0





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